



Features

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Low Input Capacitance

Mechanical Data

Low Input/Output Leakage

Case: TO220AB (Type TH)

High BV_{DSS} Rating for Power Application

Flammability Classification Rating 94V-0

Solderable per MIL-STD-202, Method 208 (3)

Terminal Connections: See Diagram Below

Weight: 1.85 grams (Approximate)

Lead-Free Finish; RoHS Compliant (Notes 1 & 2) Halogen and Antimony Free. "Green" Device (Note 3)

Case Material: Molded Plastic, "Green" Molding Compound, UL

Terminals: Matte Tin Finish Annealed over Copper Leadframe.

DMG7N65SCT

N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)}	Package	Ι _D T _C = +25°C
650V	1.4Ω@V _{GS} = 10V	TO220AB (Type TH)	7.7A

Description

This new generation MOSFET features low on-resistance and fast switching, making it ideal for high efficiency power management applications.

Applications

- Motor Control
- Backlighting
- DC-DC Converters
- Power Management Functions

TO220AB (Type TH)



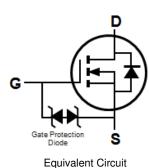
Notes:

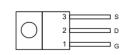


Top View



Bottom View





Top View Pin Out Configuration

Ordering Information (Note 4)

Part Number	Case	Packaging
DMG7N65SCT	TO220AB (Type TH)	50 pieces/tube

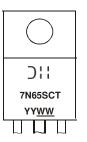
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

 See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Haloger- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



) | | = Manufacturer's Marking 7N65SCT = Product Type Marking Code YYWW = Date Code Marking YY or \underline{YY} = Last Two Digits of Year (ex: 16 = 2016) WW or \underline{WW} = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic Drain-Source Voltage			Symbol	Value 650	Units V
			V _{DSS}		
Gate-Source Voltage			V _{GSS}	±30	V
Continuous Drain Current (Note 5) $V_{GS} = 10V$	Steady State	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	ID	7.7 4.8	А
Maximum Body Diode Forward Current (Note 5)			I _S	10	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	10	A
Avalanche Current, L = 60mH (Note 6)			I _{AS}	1.1	A
Avalanche Energy, L = 60mH (Note 6)			E _{AS}	42	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Units		
Tatal Dowar Dissinction (Nato E)	$T_{C} = +25^{\circ}C$	P	125	w	
Total Power Dissipation (Note 5)	$T_{\rm C} = +100^{\circ}{\rm C}$	PD	50	vv	
Thermal Resistance, Junction to Ambient (Note 5)		$R_{ ext{ heta}JA}$	50	00 MM	
Thermal Resistance, Junction to Case (Note 5)		R _{0JC}	1	°C/W	
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C		

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

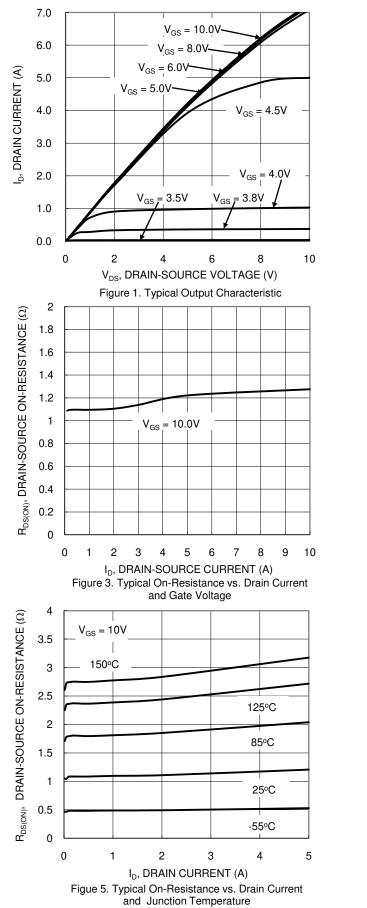
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	650	_	_	V	$V_{GS} = 0V, I_{D} = 250 \mu A$
Zero Gate Voltage Drain Current	I _{DSS}		_	1	μA	$V_{DS} = 650V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}		_	10	μA	$V_{GS} = \pm 24V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	2	—	4	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	1.1	1.4	Ω	$V_{GS} = 10V, I_D = 2.5A$
Diode Forward Voltage	V _{SD}		0.8	1.5	V	$V_{GS} = 0V, I_{S} = 5A$
DYNAMIC CHARACTERISTICS (Note 6)						
Input Capacitance	Ciss	_	886			$\label{eq:VDS} \begin{array}{l} V_{DS}=50V,f=1.0MHz,\\ V_{GS}=0 \end{array}$
Output Capacitance	Coss		63		pF	
Reverse Transfer Capacitance	Crss	_	8.9	_		
Gate Resistance	R _G	_	1.4		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V _{GS} = 10V)	Qg	_	25.2			
Gate-Source Charge	Qgs	_	3.5	_	nC	$\label{eq:VDS} \begin{array}{l} V_{DS} = 480V, \ I_{D} = 5A, \\ V_{GS} = 10V \end{array}$
Gate-Drain Charge	Q _{gd}	_	12.4	_		
Turn-On Delay Time	t _{D(ON)}	_	10			
Turn-On Rise Time	t _R	_	11			$\label{eq:VDS} \begin{array}{l} V_{DS}=300V,\ R_{G}=4.7\Omega,\ I_{D}=2.5A,\\ V_{GS}=10V \end{array}$
Turn-Off Delay Time	t _{D(OFF)}		36		ns	
Turn-Off Fall Time	t _F	_	15	_]	
Body Diode Reverse Recovery Time	t _{RR}	_	271		ns	
Body Diode Reverse Recovery Charge	Q _{RR}	_	1908	_	μC	$V_{DS} = 60V, I_F = 5A, dI/dt = 100A/\mu s$

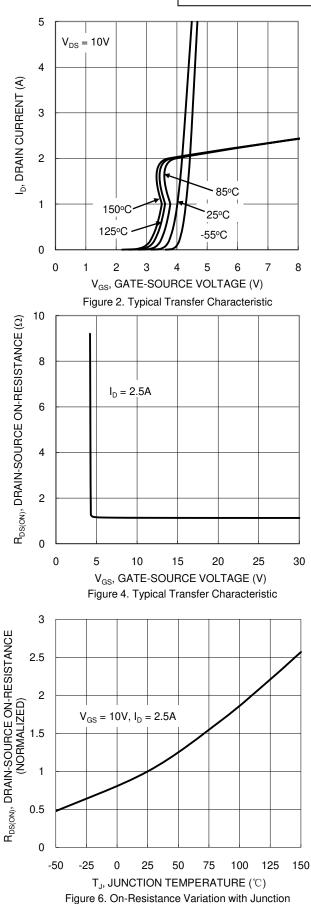
Notes: 5. Device mounted on an infinite heatsink.

Guaranteed by design. Not subject to production testing.
Short duration pulse test used to minimize self-heating effect.



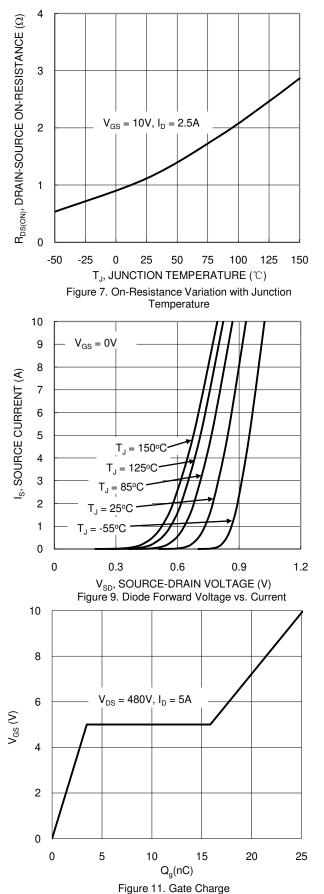
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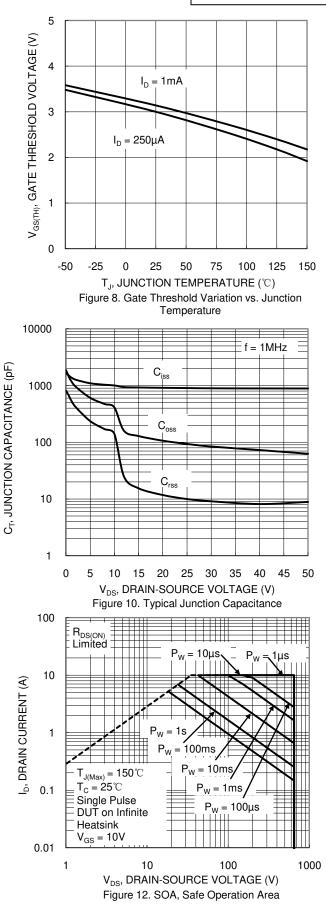






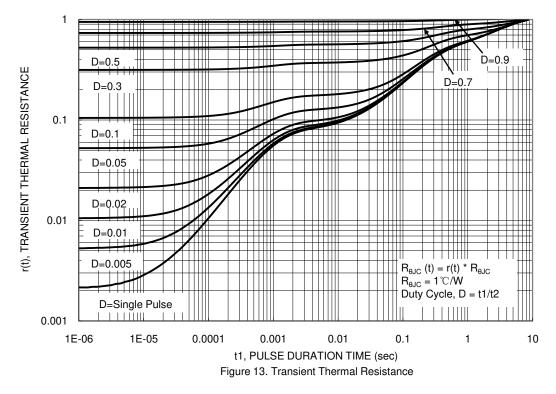
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DMG7N65SCT Document number: DS39327 Rev. 2 - 2

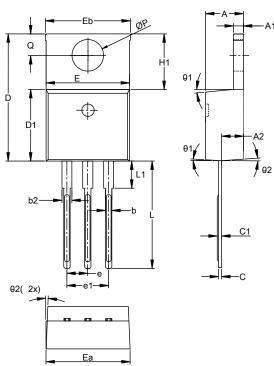


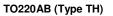




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.





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D2a D2

-E2b--E2a

-E2

TO220AB (Type TH)						
Dim	Min	Max	Тур			
Α	4.27	4.87	4.57			
A1	1.12	1.42	1.27			
A2	2.39	2.99	2.69			
b	0.70	1.01	0.81			
b2	1.17	1.50	1.27			
С	0.30	0.53	0.38			
c1	0.38	0.72	0.56			
D	14.60	15.40	15.00			
D1	8.40	9.00	8.70			
D2	5.33	6.63	6.33			
D2a	4.54	4.54 5.84				
е		2.54 BSC				
e1		5.08 BSC				
Е	9.88	10.50	10.16			
Ea	9.90	10.45	10.10			
Eb	9.90	10.65	10.25			
E2	7.06	8.36	8.06			
E2a	6.67	7.97	7.67			
E2b	4.94	6.24	5.94			
H1	5.70	6.65	6.30			
L	13.00	13.80	13.40			
L1	-	4.10	3.75			
Q	2.50	2.99	2.74			
ØP	3.70	3.99	3.84			
θ1	4°	10°	7°			
θ2	0°	6°	3°			
All Dimensions in mm						

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